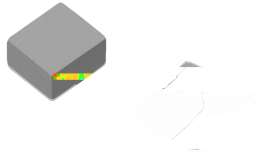


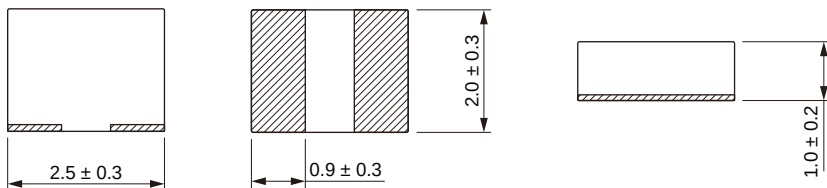
Wire Wound Molded SMD Power Inductors Size 25201B



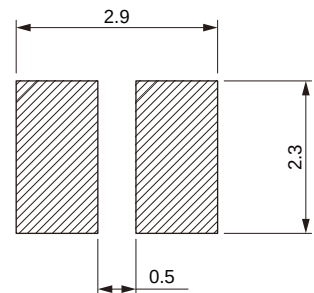
- {2D äI-údzNl-ə2y
- I λEK ÖdzNlNŠyúsf2θ 5 /wλKλEK ŠYöλŠyöð
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- 5 /κ5 / Ö2yÖŠNúŠN

Dimensions: [mm]



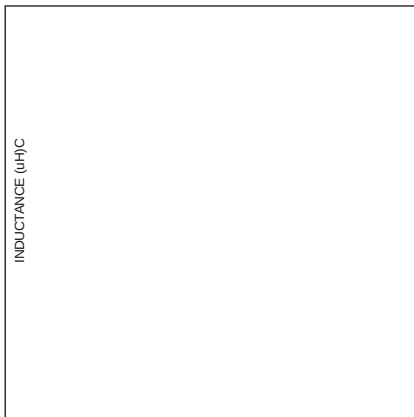
Land Pattern: [mm]



Part No	Inductance @ 1MHz/1V	Tolerance	Current Typ.	Current Max.	Temperature Rise Current Typ.	Temperature Rise Current Max.	DC Resistance Max.

Saturation Current will cause L to drop approximately 30%
Temperature Rise Current: The actual value of DC current when the temperature rise is ΔT=40°C

Typical Electrical Characteristics:



Soldering Reflow:



Packaging Information:

Tape Dimension:



Series	A0 (mm)	B0 (mm)
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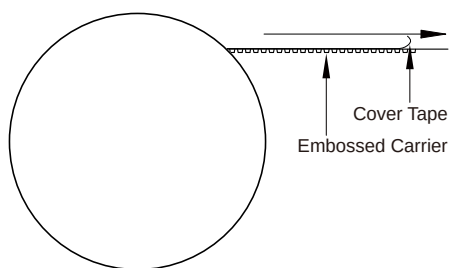
MDTE25201B

Peel force of top cover tape:

The diagram illustrates the peel force of the top cover tape. It shows a horizontal line representing the tape, with several rectangular notches below it. A line labeled 'F' is shown peeling the 'Top cover tape' from the 'Base tape' at an angle of 165°-180°.

The peel force of top cover tape shall be betw os

Reel Dimension: [mm]



Packaging Quantity: